



19 - Lasers

Name: _____

In-Class Problems

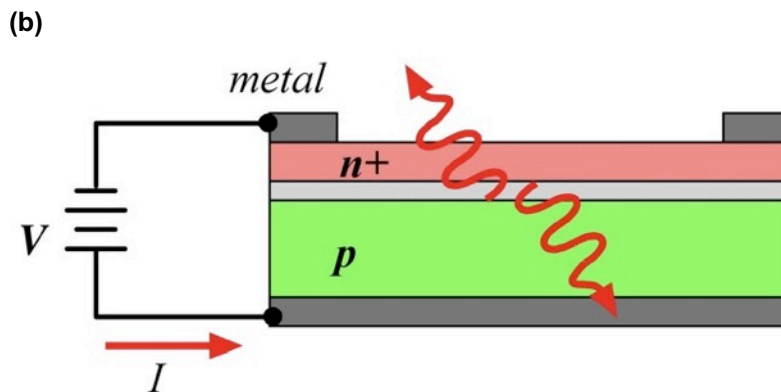
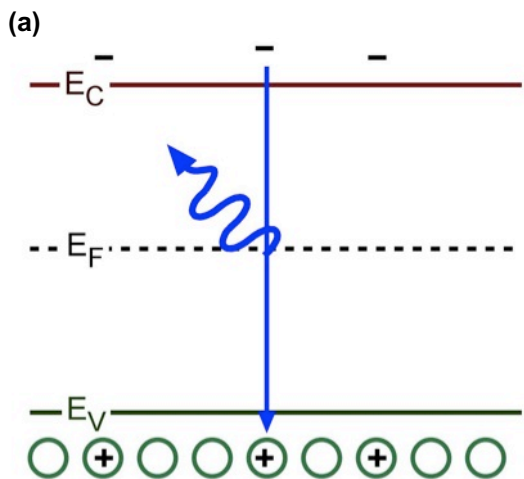
(1) We form a simple PN junction in Si, which of the following devices can be made from this PN junction in Si? Simply circle them.

- Diode Solar Cell Photodetector Light Emitting Diode Transistor

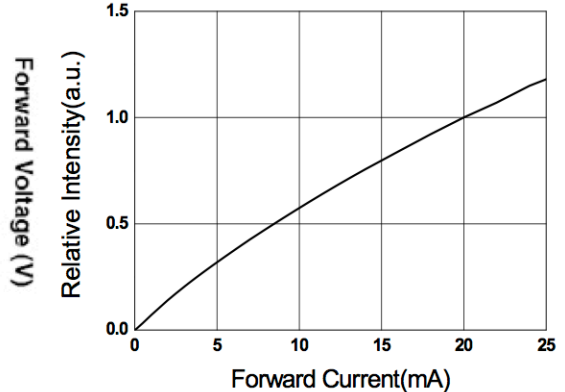
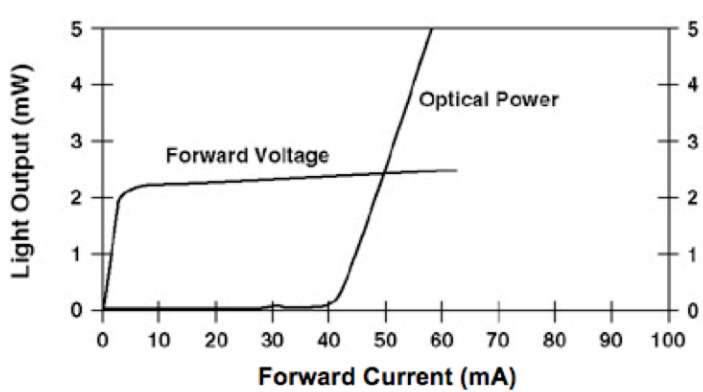
(2) See the light emitting devices below.

For the band-diagram in (a), there are TWO things missing that shows us that this is not a LASER, what are they?

For the device diagram in (b), the device requires TWO device structure modifications to become a laser, what are they?



(3) Here are two light emitting semiconductor devices. Label on each diagram where any of the following are occurring: no emission (N), spontaneous emission (S), lasing (L):



(4) Lasers use mirrors which are:

- made of highly reflective metal like Al or Ag, because they are inexpensive
- made of alternating refractive index dielectric layers that allow multiple back-reflections in the laser without loss
- both
- neither

(5) See the product spec sheet below. Using only the spec sheet, answer these questions:

- (a) at maximum, what is the bandgap energy of InAlAs?
- (b) in the block diagram, on what component does the light shine?
- (c) for the photodetector portion, what is its reverse saturation current?



RECEIVER NR4210 Series

InAIAs APD RECEIVER WITH INTERNAL PRE-AMPLIFIER FOR 10 Gb/s APPLICATIONS

DESCRIPTION

The NR4210 Series products consist of InAIAs-APD (avalanche photo diode) ROSAs (Receiver Optical Sub-Assembly) with internal pre-amplifiers designed for 10 Gb/s long-reach optical transceivers such as the XENPAK/X2/XFP. These modules are ideal as receivers for IEEE 10G BASE and SONET OC-192 systems.

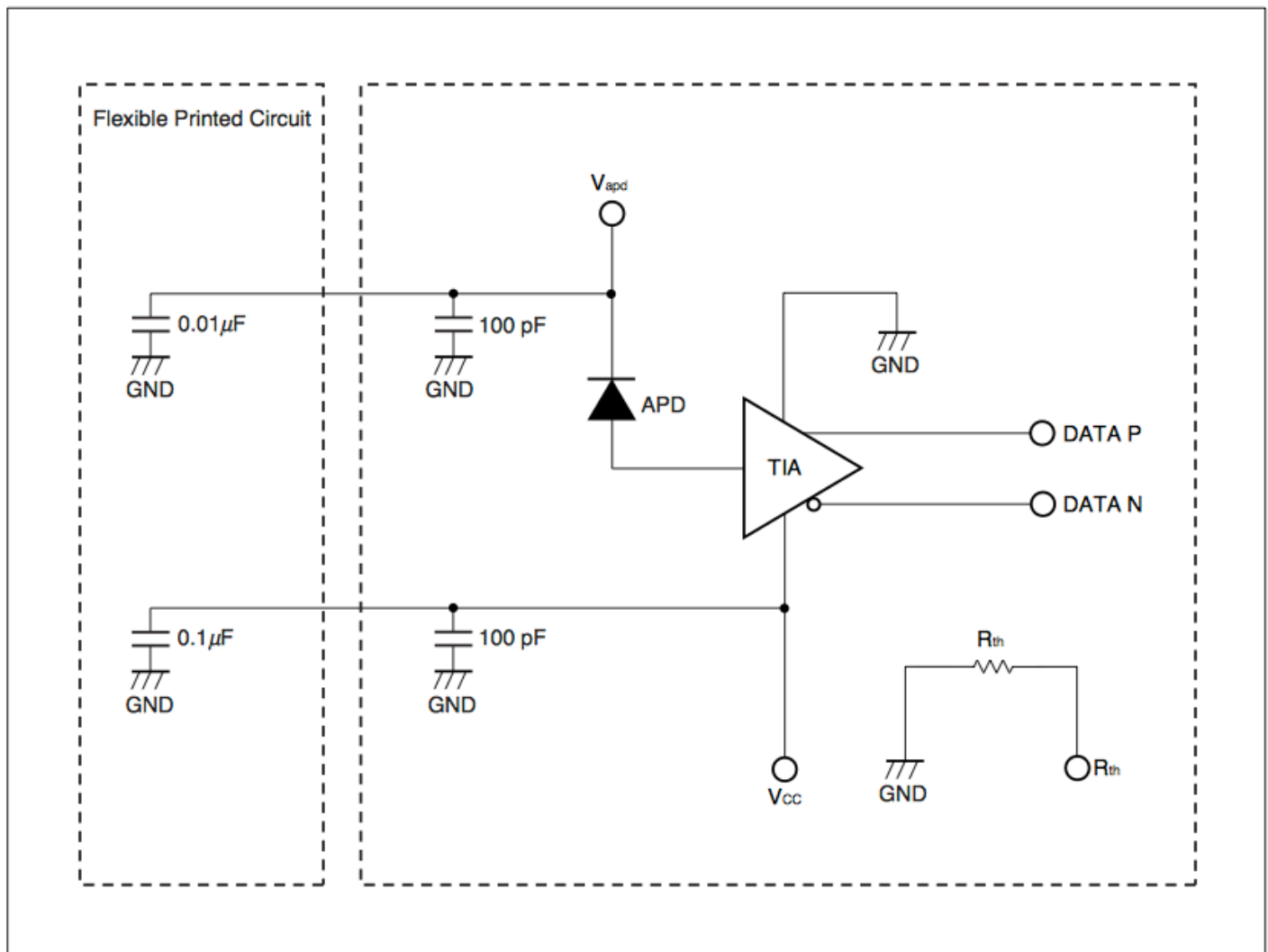
FEATURES

- XMD-MSA compliant ROSA
- 10 Gb/s high sensitivity InAIAs-APD
- +3.3 V SiGe transimpedance pre-amplifier
- Minimum receiver sensitivity $\bar{P}_r = -28$ dBm
- Operating case temperature $T_c = -5$ to $+85^\circ\text{C}$
- Transimpedance $Z_i = 2\,000\ \Omega$ (Single-ended)
- Cut-off frequency $f_c = 8$ GHz
- With flexible printed circuit



ELECTRO-OPTICAL CHARACTERISTICS ($T_c = -5$ to $+85^\circ\text{C}$, $V_{CC} = +3.3$ V, $\lambda = 1\,550$ nm, unless otherwise specified)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
APD Sensitivity	S	$\lambda = 1\,310$ nm, $M = 1$	0.75	0.9		A/W
		$\lambda = 1\,550$ nm, $M = 1$	0.75	0.9		
APD Breakdown Voltage	V_{BR}	$I_D = 10\ \mu\text{A}$	25	30	35	V
Temperature Coefficient of APD Breakdown Voltage	δ^{-1}	$T_c = +25$ to $+85^\circ\text{C}$	0	0.02	0.05	V/ $^\circ\text{C}$
APD Dark Current	I_D	$V_R = V_{BR} \times 0.9$, $T_c = +25^\circ\text{C}$			0.7	μA

BLOCK DIAGRAM

(6) Recent press release on a new device used to modulate a continuous laser signal into 1's and 0's of optical pulses for high-speed fiber communications. This is an example of how you can start to reverse engineer someone's technology using not much more than a press-release. Is a bit challenging to figure out at first.

- (a) Explain how you believe that this device works. *Hint, see slide 20 of the lecture, but note that in the press release statement below, they use an MOS approach (not a PN junction) to modulate carrier concentration and therefore cause a change in refractive index. If you answer part (a) correctly, you will realize that to achieve a maximum change in refractive index for the two waveguide arms (sides) you will apply some sort of voltage to both arms of the interferometer. Use MOSFET terminology in your answers.*
- (b) Assume the device uses the standard telecom wavelength of $1.5 \mu\text{m}$ light (which is low enough energy that Si does not absorb it!), and the refractive index of the waveguide is nominally $n=3.5$. Calculate how much difference in refractive index is needed between the two arms of the waveguide to cause a logic zero (0) to be created at the output of this modulator?

- *Hint, 1st calculate the actual wavelength for $1.5 \mu\text{m}$ light inside this Si material (remember, it will decrease it according to λ/n).*

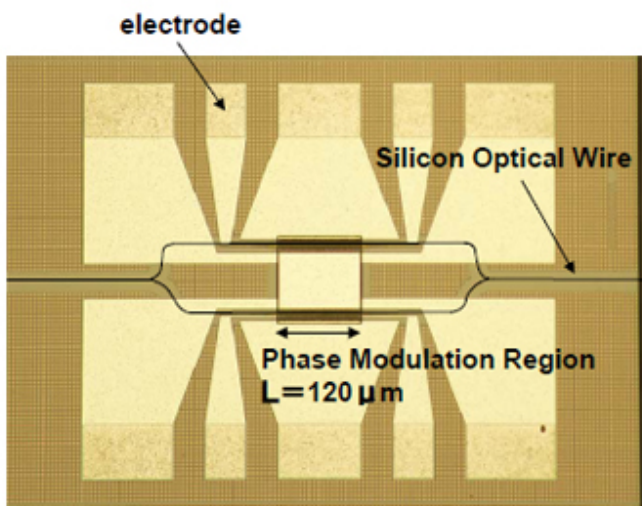
- *Then figure out how many of these wavelengths you can fit along one arm using the length stated in the press release.*

- Then remember to get negative interference (create a logic zero) you simply need to be a half-wavelength out of phase, and calculate how much as a % this is of the total number of wavelengths along one arm. Multiply this % by the refractive index and you have the amount by which you need to change the refractive index!

(c) Next, do a sanity check for your answer using this equation, to determine if such a change in refractive index is even possible for Si:

$$\Delta n \cong 3 \times 10^{-21} (cc) \times \Delta N \left(\frac{1}{cc} \right)$$

(d) Lastly, they are clearly bragging in the press release about how compact this size is. From an end user perspective, this is nice, but not a major advantage (is already pretty small). However, from a manufacturing and profit perspective for the company, this is a big deal... why?



Tokyo, March 23, 2010 - NEC Corporation (NEC; TSE: 6701), announced today the successful development of a silicon MOS (metal-oxide-semiconductor) optical modulator that boasts a leading power-consumption efficiency of less than 1mW/Gbps, a compact size of 120 μm in length and high-speed operation of 25Gbps. The device has only one-tenth the power consumption when compared to conventional PN-type silicon optical modulators.

(7) Simulate a 1D photonic crystal reflector for a RED laser using a very nice MATLAB script file written by David Kiesewetter, Hunter Covington, and Matt Farr (class of 2015). See the zip file on blackboard for everything you need.

Use input $n_0=1$ (air), first layer $n_1=1.46$ (SiO_2), second layer $n_2=2.35$ (TiO_2), output $n_0=1$ (air). Plot from 400 nm to 900 nm, 500 data points. You should:

- (a) simulate 3 layer repeats for $\lambda_0=633$ nm and each layer thickness equal to $\lambda_0/4n$;
- (b) simulate 10 layer repeats for $\lambda_0=633$ nm and each layer thickness equal to $\lambda_0/4n$;

